## **公TDK**

June 2020



## Chip varistors

Voltage Protection Devices

Automotive grade



AVRM, AVR-M series	
AVRM1608/AVR-M1608	JIS 1608 [EIA 0603]
AVRM2012/AVR-M2012	JIS 2012 [EIA 0805]
AVRL series	
AVRL10	JIS 1005 [EIA 0402]
AVRL16	JIS 1608 [EIA 0603]
AVRH series	
AVRH10	JIS 1005 [EIA 0402]

Product compatible with RoHS directive Compatible with lead-free solders AEC-Q200

## **Overview of the AVR series**

#### CHARACTERISTICS OF CHIP VARISTOR

Varistors are voltage dependent nonlinear resistive elements with a resistance that decreases rapidly when the voltage is over the constant value.

Varistors become zener diode of 2 serial connection and equivalent, and does not have polarity.

#### **CURRENT vs. VOLTAGE CHARACTERISTICS**



#### □ THE EFFECT OF THE VARISTOR

#### Without varistor

A malfunction and failure of electronic equipment



#### With Varistor

Suppress transient voltage by inserting varistor in a circuit



#### EQUIVALENT CIRCUIT OF CHIP VARISTORS



A capacitance content

#### CHIP VARISTORS FEATURE FOR AUTOMOTIVE

#### GRADE

- Reliability characteristics evaluated based on AEC-Q200 condition.
- O High ESD withstanding voltage
- Small-sized products are available
- 125°C, 150°C Supported

#### Figure 1 internal structure of multilayer chip varistors



No.	Name			
(1)	Semiconductor ceramic			
(2)	Internal electrode(Pd)	Internal electrode(Pd)		
(3)		Ag		
(4)	Terminal electrode	Ni		
(5)	_	Sn		

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## **Overview of the AVR series**

#### **COMMUNICATION STANDARD, CIRCUIT EXAMPLE AND COMMUNICATION STANDARD**

		LIN/CXPI	Classical CAN	CAN/CAN-FD	
Туре	Dimensions code JIS [EIA]	LIN/CXPI Transceiver	CAN Transceiver	CAN Transceiver Connector CMF N Varistor	
		20 kbps	1 Mbps	2-8 Mbps	
Chin	1005 [0402]	N/A	AVRH10C270KT150NA8	AVRH10C270KT150NA8	
varietore	Stors         1608 [0603]         AVRM1608C270KT221M           2012 [0805]         N/A		AVR-M1608C270MTAAB	AVR-M1608C270MTABB	
variators			N/A	N/A	



		One-Pair Ethernet 100BASE-T1	One-Pair Ethernet 1000BASE-T1	Motors
Туре	Dimensions code JIS [EIA]	100BASE-T1 PHY Varistor N H	1000BASE-T1 PHY Varistor	•Varistor (ESD)
		100Mbps	1000Mbps	-
Chip	1005 [0402]	AVRH10C101KT4R7FA8	AVRH10C101KT1R1NE8 AVRH10C221KT1R5YA8	N/A
varistors	1608 [0603]	N/A	N/A	AVR-M1608C270KT6AB
	2012 [0805]	N/A	N/A	AVR-M2012C390KT6AB

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## **Overview of the AVR series**

#### PART NUMBER CONSTRUCTION

AVRM	1608	3	С	3	90		Κ			Т			271		٢	١
Series name	L x W dimension (mm)	ns Struc	ture code	Varisto (	r voltage V)	Vari 1	stor volta olerance (%)	ige	Pac	kaging	style	Capa inter	acitance o nal specia symbol (pF)	r (	Capac toler (%	itance ance %)
AVRM series	1608 1.6>	«0.8 C	General structure	390=	39×10 <sup>0</sup>	к	±10		т	Тарі	ng	27	1=27×10 <sup>1</sup>		к	±10
	2012 2.0>	(1.2		220	22	M	±20		В	Bul	k	221	220		M	±20
			-	390	39		100						210			100
AVR-M	1608	3	C	2	70		Μ			Т		ŀ	AAB			
						·								_		
Series name	L x W dimension (mm)	ns Struc	ture code	Varisto (	r voltage V)	Vari 1	stor volta olerance (%)	ige	Pac	kaging	style	Co spec	ompany ial symbo	I		
AVR-M series	1608 1.6>	<0.8 C	General structure	270=	27×10 <sup>0</sup>	К	±10		т	Тарі	ng					
	2012 2.0>	(1.2	_	220	22	M	±20		В	Bul	k	_				
			-	390	39	<u> </u>	±30									
AVRL	10		1A		3R3	3		F			Т		A			
Series name	L x W dimension (mm)	ns conti	Maximum nuous volta (Vdc)	ge	Capacita (pF)	nce	Capae tolei (p	citan rance oF)	ce e	Packa	aging	style	Comp special s	any ymbo	1	
AVRL series	10 1.0>	<0.5 1A	10	3	3R3 3	.3	F	±1		Т	Тар	ing				
L=LOW Cap	10 1.0	(0.0				.0	G	±Ζ		D	DU	IK				
AVRH	10	С	270		K		Т		15	50		N	A			8
Series name	L x W dimensions (mm)	Structure code	Varistor voltage (V)	Va V tol	aristor oltage lerance (%)	Pack	aging sty	le C	apaci	itance F)	Cap tol	acitance erance	ESD vo amou IEC6100 (kV	ltage int 10-4-2 )	Ope temp I	erating perature imit (°C)
AVRH series	10 1.0×0.5 (	General structure	270=27×10	00 K	±10	т	Taping	1	50=1	5×10 <sup>0</sup>	Ν	±30%	Α	25	8	150
H=High Reliability			2702739039101100		<u> </u>	В	Bulk		150 500 4R7	15 50 4.7	F	±1pF				
	T Sh	ape symbol(	JIS) L		W		т			в						

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1005

1608

2012

1.00±0.05

1.60±0.1

2.00±0.2

 $0.50 \pm 0.05$ 

0.80±0.1

1.25±0.2

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0.50±0.05

0.80±0.1

1.00±0.2

0.1min.

0.2min.

0.2min.

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## **Overview of the AVR series**

#### OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range	Package quantity	Individual weight	
Туре	Operating temperature* (°C)	Storage temperature** (°C)	(pieces/reel)	(mg)	
AVRM1005 AVR-M1005 AVRL10	-40 to +125	-40 to +125	10,000	1.2	
AVRH10	-55 to +150	-55 to +150			
AVRM1608 AVRL16 AVR-M1608	-40 to +125	-40 to +125	4,000	5	
AVR-M2012			2,000	13	

\* Operating temperature range includes self-temperature rise.

\*\* The storage temperature range is for after the assembly.

#### TERMINOLOGY

Item	Unit	Description		
Varistor voltage	V1mA	Chin verieter terminal valters when DCtrs ( was flawed		
(Breakdown voltage)	(V)	Chip varistor-terminal voltage when DC ImA was nowed		
	Vda	DC voltage that is continuously applied between chip varistor terminals		
Maximum continuous voltage		Terminal chip varistors leakage current-value: 50μA max		
-	(V)	Voltage appearing across the varistor when a pulse current (8/20µs*1) of specified peak value is applied.		
Clamping voltage	Vcl	Voltage between terminal chip varistors of the Specified peak current value of the impulse curren		
Clamping voltage	(V)	20μs*1) is applied		
Maximum anargu	E	When applied specified peak impulse current-value current(10/1000µs*2) once, maximum energy that		
Maximum energy	(Joule)	electrical property of chip varistors be not deteriorated		
Maximum pack aurrant	lp	When applied impulse current(8/20µs*1) once, maximum current that electrical property of chip varistors		
Maximum peak current	(A)	be not deteriorated		
Canacitanaa	С	Oscillator frequency 1kHz or 1MHz, Capacitance between chip varistor-terminal in oscillator voltage		
Capacitance	(pF)	1 Vrms		



\*2 10/1000µs test waveform



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## AVR series (Automotive grade) Product characteristics list

#### PRODUCT CHARACTERISTICS LIST

Item	Size	V (1mA)	C1kHz *C1MHz	Vdc	Clamping voltage 8/20µs Pulse	Maximum energy 10/1000µs Pulse	Maximum peak current 8/20µs Pulse	IEC61000-4-2 (Contact)	AEC- Q200
	(mm)	(V)	(pF)	DC (V)	Vcl (V)		lp (A)	<b>150pF/330</b> Ω	
AVRL101D3R3FTA	1.0 x 0.5 (EIA0402)	27(21.6 to 32.4)	3.3(2.3 to 4.3)*	20	62(0.5A)	0.01	0.5	8kV	~
AVRL101D6R8GTA	1.0 x 0.5 (EIA0402)	27(21.6 to 32.4)	6.8(4.8 to 8.8)*	20	58(1A)	0.01	1	8kV	<b>v</b>
AVRH10C270KT150NA8	1.0 x 0.5 (EIA0402)	27(24.0 to 30.0)	15(10.5 to 19.5)	19	52(2A)	0.02	2	25kV	~
AVRH10C270KT350NA8	1.0 x 0.5 (EIA0402)	27(24.0 to 30.0)	35(24.5 to 45.5)	19	52(2A)	0.02	8	25kV	<b>v</b>
AVRH10C390KT500NA8	1.0 x 0.5 (EIA0402)	39(35.0 to 43.0)	50(35 to 65)	28	72(2A)	0.02	15	25kV	~
AVRH10C101KT4R7FA8	1.0 x 0.5 (EIA0402)	100(90 to 110)	4.7(3.7 to 5.7)*	70	190(1A)	0.03	1	25kV	<b>v</b>
AVRH10C101KT1R1NE8	1.0 x 0.5 (EIA0402)	110(100 to 120)	1.1(0.8 to 1.4)*	70	190 (0.3A)	0.01	0.3	8kV	~
AVRH10C221KT1R5YA8	1.0 x 0.5 (EIA0402)	220 (198 to 242)	1.5(1.37 to 1.63)*	70	400 (0.5A)	0.01	0.5	25kV	
AVRL161D3R3FTA	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	3.3(2.3 to 4.3)*	20	62(0.5A)	0.01	0.5	8kV	~
AVRL161D6R8GTA	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	6.8(4.8 to 8.8)*	20	58(1A)	0.01	1	8kV	~
AVR-M1608C220KT2AB	1.6 x 0.8 (EIA0603)	22(19.8 to 24.2)	210(147 to 273)	16	37(2A)	0.03	10	25kV	~
AVR-M1608C220KT6AB	1.6 x 0.8 (EIA0603)	22(19.8 to 24.2)	560(392 to 728)	16	34(2A)	0.10	30	25kV	~
AVR-M1608C270MTABB	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	15(10.5 to 19.5)	17	52(2A)	0.05	2	25kV	~
AVR-M1608C270MTAAB	1.6 x 0.8 (EIA0603)	27(21.6 to 32.4)	30(21 to 39)	17	52(2A)	0.05	2	25kV	~
AVR-M1608C270KTACB	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	60(42 to 78)	19	54(2A)	0.05	10	25kV	~
AVRM1608C270KT800M	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	80(64 to 96)	19	53(2A)	0.02	28	25kV	~
AVR-M1608C270KT2AB	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	160(112 to 208)	19	42(2A)	0.10	20	25kV	~
AVRM1608C270KT221M	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	220(176 to 264)	19	52(2A)	0.10	40	25kV	~
AVR-M1608C270KT6AB	1.6 x 0.8 (EIA0603)	27(24.0 to 30.0)	430(301 to 339)	19	42(2A)	0.10	48	25kV	~
AVRM1608C390KT271N	1.6 x 0.8 (EIA0603)	39(35.0 to 43.0)	270(189 to 351)	28	69(2A)	0.10	78	25kV	~
AVRM1608C560KT101M	1.6 x 0.8 (EIA0603)	56(50.4 to 61.6)	100(80 to 120)	40	113(2A)	0.10	60	25kV	~
AVRM1608C720KT750M	1.6 x 0.8 (EIA0603)	72(64.8 to 79.2)	75(60 to 90)	53	135(2A)	0.10	40	25kV	~
AVR-M2012C220KT6AB	2.0 x 1.2 (EIA0805)	22(19.8 to 24.2)	800(560 to 1040)	16	38(5A)	0.30	100	25kV	~
AVRM2012C330KT801N	2.0 x 1.2 (EIA0805)	33(29.7 to 36.3)	800(560 to 1040)	24	59(5A)	0.50	240	25kV	~
AVR-M2012C390KT6AB	2.0 x 1.2 (EIA0805)	39(35.0 to 43.0)	430(301 to 559)	28	62(5A)	0.30	100	25kV	~
AVRM2012C560KT251M	2.0 x 1.2 (EIA0805)	56(50.4 to 61.6)	250(200 to 300)	40	113(5A)	0.30	150	25kV	~
AVRM2012C720KT201M	2.0 x 1.2 (EIA0805)	72(64.8 to 79.2)	200(160 to 240)	53	142(5A)	0.30	100	25kV	~

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### Automotive grade

AVR series Electrostatic absorption characteristics

#### DISCHARGE VOLTAGE WAVEFORM (EXAMPLE)

**WITHOUT VARISTOR, WAVEFORM AT VARISTOR INSTALLATION** 



□ WAVEFORM AT VARISTOR INSTALLATION



Test conditions
150pF/330Ω (IEC61000-4-2)
Contact discharge, Charged voltage 8kV

#### **TEST CIRCUIT DIAGRAM**



# AVR series Electrostatic discharge tests

#### APPLIED VOLTAGE STEP(VOLTAGE 10TIMES APPLIED) REPEATED VOLTAGE APPLICATION(~1000 times )

□AVRH10C270KT150NA8 (Voltage % change at reference current: within ±10%)





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□AVR-M2012C390KT6AB (Voltage % change at reference current: within ±10%)



□AVRL101D3R3FTA(Capacitance: 5pF or less)



\* ESD condition: 150pF/330Ω(IEC61000-4-2)







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+25kV/-25kV

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## Attention on a circuit board design

#### **Board design**

When attached to chip varistors, amount of silver used (fillet size) has direct impact on chip varistors after mounting. Thus, sufficient consideration is necessary.

#### Set of land dimensions

(1) As the stress rises in the chip varistors owing to the increase in silver, breakage and cracks will occur. Cause including crack, as caution on board land design, configure the shape and dimensions so that the amount of silver is appropriate. If you installed 2 or more parts in the Common Land, separated by a solder resist and special land of each component.



Dimonsions shane	Symbol					
Dimensions shape	Α	В	С			
1005	0.30 to 0.50	0.35 to 0.45	0.40 to 0.60			
1608	0.60 to 0.80	0.60 to 0.80	0.60 to 0.80			
2012	0.90 to 1.20	0.70 to 0.90	0.90 to 1.20			

(2) When peak levels panning-at soldering is excessive, by solder contraction stress, mechanical-thermal stress causes a Yasuku chip crack. In addition, when the peak level is underestimated, terminal electrode fixed strength is insufficient. This causes chip dropouts and may affect circuit reliability. Representative example of the panning of peak levels is shown in the following.

#### Recommended silver dose



#### Case and suggested protocol want to avoid



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## Attention on a circuit board design

#### Arrangements of components

(1) I was based on camber of substrate and suggested protocol of chip varistors arrangement, as stress does not join to the utmost is shown in following.



(2) In payment near by board, depending on mount position of chip varistors, as mechanical stress varies, please refer to the following diagram.





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## **Local precautions**

#### Application to board

#### Mounting head pressure

Under suction nozzle if dead point too, during implementation, excessive force joins of chip varistors low, as cause causes of crack, please use with reference to something about following.

- Being set to top surface of substrate so that under suction nozzle as for dead center, substrate does not bend back, and adjust, please.
- 2) Nozzle pressure at implementation is 0.1 to 0.3N in static load, please.
- Substrate fixes up back surface of substrate with support pin in impact of suction nozzle to wely deflection to the utmost, and substrate hold deflection, please. A representative example is shown in the following.



Mechanical shock that, if positioning your nail to wear, ragged edge of positionings, participates in chip varistors are locally, and chip varistors, as there is possibility of crack generated, cut the closed positioning, and maintenance and inspection, and, exchange of manage dimensions and position nail periodically, please.

#### Soldering

Significant impact is possible on the performance of chip varistors, flux checks something about follow, please use.

(1) Flux uses one with 0.1wt % (Cl conversion) or less halide substance contains amounts, please. In addition, do not do this with strongly acidic objects.

Flux during is soldered (2) Chip varistors is applied the smalleset amount necessary, please.

(3) If Used soluble flux, perform thorough wash particularly, please.

Reflow temperature profile



	Specification	
tem	For eutectic mixture	Use of lead-free
	solder	solder
Preheating temperature	160 to 180°C	150 to 180°C
Solder melting temperature	200°C	230°C
Maximum temperature	240°C max.	260°C max.
Preheating time	100s max.	120s max.
Time to reach higher than the	30s max.	40s max.
solder meiting temperature		
number of possible reflow cycles	2 max.	2 max.

#### Soldering iron

The tip temperature and also by (1) types of soldering irons, the size of the substrate, and the geometry of the land pattern. Being earlier, but when as there is possibility that crack occurs in the heat anderson impaction, point soldering iron temperature is high, please do solder work within the following conditions.

Temperature of iron tips (°C)	Wattage (W)	Pallet point shape (mm)	Soldering time (Second)	Frequency
350max.	30max.	ø3.0max.	5 max.	Within each terminal once (Within total of twice)

Direct iron tip is in contact with the (2) chip varistors body, and the strain owing to thermal shock in particular grows even if a crack is generated. Therefore, please do not touch it directly to the terminal electrodes.

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#### **Voltage Protection Devices**

### Chip varistors Automotive grade

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#### Cleaning

(1) If cleaning liquid is inappropriate, residues and other foreign body of fluxes builds up on chip varistors, and can degrade the performance of chip varistors (particularly the insulation resistance).(2) Wash conditions may compromise performance of chip varistors if they are improper (wash due, wash excess).

#### 2-1) For wash due

- (a) By substance of a system in flux residue halide, metal including terminal electrodes may experience corrosion.
- (b) Substance of a system in flux residue halide builds up on chip varistors, and reduces the insulation resistance.
- (c) Soluble flux makes comparisons of colophony series flux, and there is event with trends of significant (1) and(2).

#### 2-2) For excess wash

- (1) Owing to lavage, chip varistors deteriorates, and reduces performance of chip varistors.
- (2) In ultrasonography, when output is passed, substrate resonates size, and crack occurs in body and sprang of chip varistors in vibration of substrate. Since this may reduce the strength of the terminal electrode, please note the following conditions. [Please review the italicized portion, as I am unsure what you mean to convey here.]
  - Ultrasound output Ultrasonic frequency Ultrasound cleaning time

2-3) Concentration including halogen that when cleaning liquid to pollution, when you released is higher, and may cause similar of results into wash due.

#### Substrate handling after component mounting

(1) When substrate is divided, a flexible so that show in following diagram to substrate, and is given by stress including twist, as there is possibility that crack occurs of chip varistors, please check that stress is within acceptable limits.



(2) During each substrate operational check, push pressure with contact failure of check pin of boards checkers of check pin may be toned up to be prevented. As substrate is bent under loading, chip varistors is broken owing to stress. There is also the possibility that solder on the terminal electrode will peel off. Follow the diagram for reference, and check that the substrate bends, please.



#### Single-part component handling

To drop impact, as there is possibility that breakage and crack is entered, do not chip varistors that(1) chip varistors falls.



(2) At stacking storage after implementation and treatment of substrate, corner of boards is regarded as chip varistors. Please be careful, as there is the possibility that breakage and cracks will occur on impact.



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### **Chip varistors**

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## **Packaging style**

#### REEL DIMENSIONS



#### PACKAGE QUANTITY / INDIVIDUAL WEIGHT

Tupo	Package quantity	Individual weight
Type	(pieces/reel)	(mg)
1005	10,000	1.3
1608	4,000	5.3
2012	2,000	13.0

#### TAPE DIMENSIONS



Dimensions in mm				
Туре	A	В	P1	Т
1005	0.65+0.05/-0.1	1.15+0.05/-0.1	2±0.05	0.65max.
1608	1.1±0.2	1.9±0.2	4±0.1	1.1max.
2012	1.6±0.2	2.3±0.2	4±0.1	1.7max.
160min. Taping 200min.				

Dimensions in mm

300min

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|••••| |

Drawing direction

### **REMINDERS FOR USING THESE PRODUCTS**

Before using these products, be sure to request the delivery specifications.

### SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

#### **▲** REMINDERS Please pay careful attention to the precautions and follow safe designing practices when using these products. O Please observe the following precautions in order to avoid problems with chip varistors such as characteristic degradation and element destruction Please store these products in an environment with a temperature of 5 to 40°C and humidity level of 20 to 70%RH, and use them within six months. Poor storage conditions may lead to the deterioration of the solderability of the edge electrodes, so please be careful to avoid contact with humidity, dew condensation, dust, toxic gas (hydrogen, hydrogen sulfide, sulfurous acid, chlorine, ammonia, etc.), direct sunlight, and so on. Please do not use products that have been dropped or detached when mounting. Please solder with the reflow soldering method, and not the flow (dip) soldering method. Please observe the following precautions to avoid problems with varistors such as characteristic degradation and element destruction. which ultimately lead to the generation of heat and smoke with the elements. Do not use in locations where the temperatures exceed the operating temperature range such as under direct sunlight or near sources of heat. Do not use in locations where there are high levels of humidity such as under direct exposure to weather and areas where steam is released. Do not use in locations such as dusty areas, high-saline environments, places where the atmosphere is contaminated with corrosive gas, etc. Avoid powerful vibrations, impact (such as by dropping), pressure, etc. that may lead to splitting in the products. Do not use with a voltage that exceeds the maximum allowable circuit voltage. When resin coating (including modular) a varistor, do not use a resin that will cause deterioration of the varistor. Be sure never to use resin that generates hydrogen as palladium is used for the inner electrode. Avoid attachment near combustible materials. Please contact our sales offices when considering the use of the products listed on this catalog for applications, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property ('specific uses' such as automobiles, airplanes, medical instruments, nuclear devices, etc.) as well as when considering the use for applications that exceed the range and conditions of this catalog. Please also contact us when using these products for automotive applications. O As range of catalog, conditions are transcended, or for damage that generated by was used in application specific, etc, accept no the responsibility, wish. Please take appropriate measures such as acquiring protective circuits and devices that meet the uses, applications, and conditions of the instruments and keeping backup circuits.